

0.8A, 200V - 600V Fast Recovery Bridge Rectifier

FEATURES

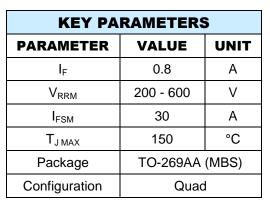
- AEC-Q101 qualified available
- Ideal for automated placement
- Reliable low cost construction utilizing molded plastic technique
- High surge current capability
- UL Recognized File # E-326854
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

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- Switching mode power supply (SMPS)
- Adapters
- Lighting application

MECHANICAL DATA

- Case: TO-269AA (MBS)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.120g (approximately)



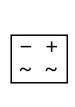


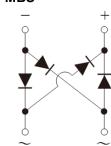












ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)						
PARAMETER		SYMBOL	RMB2S	RMB4S	RMB6S	UNIT
Marking code on the device			RMB2S	RMB4S	RMB6S	
Repetitive peak reverse voltage		V_{RRM}	200	400	600	V
Reverse voltage, total rms value		V _{R(RMS)}	140	280	420	V
Forward current	On glass-epoxy		0.5			Α
	On aluminum substrate	l _F	0.8			Α
Surge peak forward current, 8.3ms single half sine-wave superimposed on rated load		I _{FSM}	30		А	
Rating for fusing (t<8.3ms)		l ² t	3.74			A ² s
Junction temperature		TJ	- 55 to +150			°C
Storage temperature		T _{STG}	- 55 to +150			°C



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THERMAL PERFORMANCE					
PARAMETER	SYMBOL	TYP	UNIT		
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	85	°C/W		

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage per diode ⁽¹⁾	$I_F = 0.4A, T_J = 25^{\circ}C$	V_{F}	-	1	V
Deverse surrent @ reted // per diade(2)	T _J = 25°C	1	-	5	μA
Reverse current @ rated V _R per diode ⁽²⁾	T _J = 125°C	– I _R	-	100	μA
Junction capacitance per diode	1MHz, $V_R = 4.0V$	C_{J}	13	-	pF
Reverse recovery time	$I_F = 0.5A, I_R = 1.0A$ $I_{rr} = 0.25A$	t _{rr}	-	150	ns

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION				
ORDERING CODE ⁽¹⁾⁽²⁾	PACKAGE	PACKING		
RMBxS	TO-269AA (MBS)	3,000 / Tape & Reel		
RMBxSH	TO-269AA (MBS)	3,000 / Tape & Reel		

Notes:

- 1. "x" defines voltage from 200V(RMB2S) to 600V(RMB6S)
- 2. "H" means AEC-Q101 qualified



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve

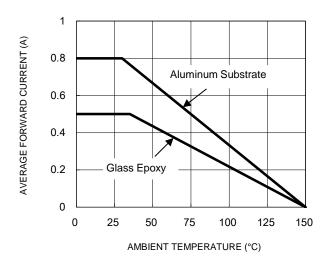


Fig.3 Typical Reverse Characteristics

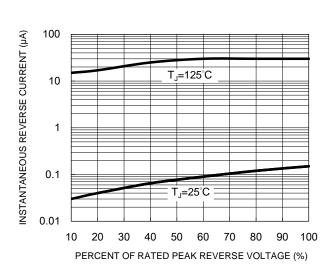


Fig.2 Typical Junction Capacitance

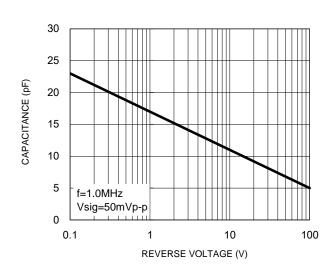


Fig.4 Typical Forward Characteristics

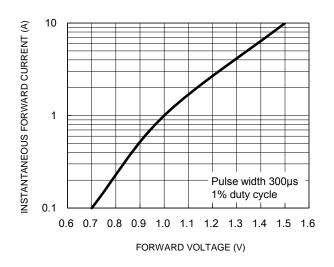
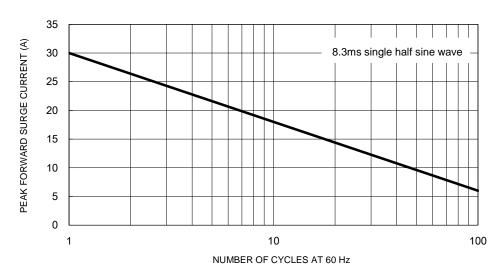


Fig.5 Maximum Non-Repetitive Forward Surge Current

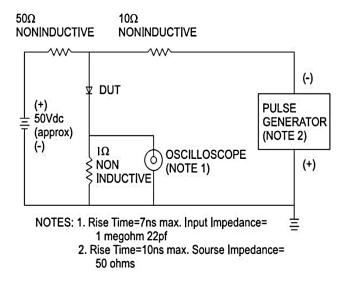


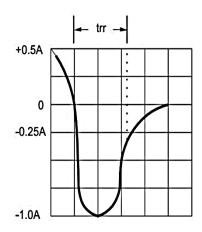


CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.6 Reverse Recovery Time Characteristic and Test Circuit Diagram

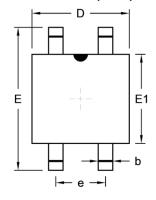


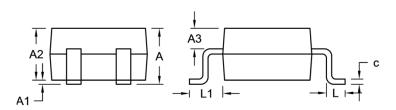




PACKAGE OUTLINE DIMENSIONS

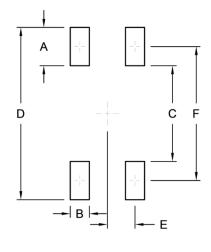
TO-269AA (MBS)





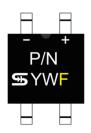
DIM.	Unit (mm)		Unit (inch)	
DIIVI.	Min.	Max.	Min.	Max.
Α	-	2.90	-	0.114
A1	-	0.20	-	0.008
A2	2.30	2.70	0.091	0.106
A3	0.95	1.53	0.037	0.060
b	0.56	0.84	0.022	0.033
С	0.15	0.35	0.006	0.014
D	4.50	4.90	0.177	0.193
E	-	6.90	-	0.272
E1	3.60	5.00	0.142	0.197
е	2.20	2.60	0.087	0.102
L	0.70	1.10	0.028	0.043
L1	1.10	2.12	0.043	0.083

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
Α	1.80	0.071
В	0.90	0.035
С	4.50	0.177
D	8.10	0.319
E	1.30	0.051
F	6.30	0.248

MARKING DIAGRAM



P/N = Marking Code YW = Date Code F = Factory Code



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